	Туре	Hits	Search Text	DBs	Tim Stamp
1	BRS	886	438/108.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/11 16:03
2	BRS	414	438/112.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/11 16:03
3	BRS	537	438/122.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/11 16:03
4	BRS	681	438/124.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/11 16:03
5	BRS	725	438/125.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/11 16:03
6	BRS	677	438/126.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/11 16:04
7	BRS	920	438/127.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/11 16:04
8	BRS	546	microelectronic adj package	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 15:21
9	BRS	4	die and (heat adj spreader) same pillars	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/11 16:21
10	BRS	2	<pre>(microelectronic adj package) and (die and (heat adj spreader) same pillars)</pre>	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/11 16:22
11	BRS	2	6114761 <i>,</i> pn.	DERWENT; IBM TDB	2004/01/11 16:23
12	BRS	2	6281573.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/11 16:23
13	BRS	2	6157086.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/11 16:23
14	BRS	2	6002171.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/11 16:23
15	BRS	2	6617682.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 15:25
16	BRS	20	(microelectronic adj package) and through?hole	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16 15:24

	Тур	Hits	Search Text	DBs	Tim Stamp
15	BRS	2	001,002.pm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	15:25
16	BRS	20	(microelectronic adi package)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/16

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